

Application No.: 09/760,741  
Amendment dated February 25, 2004  
Reply to Office Action dated December 30, 2003

Docket No.: M4065.0374/P374

**AMENDMENTS TO THE DRAWINGS**

The attached sheet of drawings includes changes to Figure 7.

Figure 7 has been amended to include cavity 25 between the first semiconductor die 20 and the supporting structure 10.

Attachment:      Replacement sheet  
                        Annotated sheet showing changes

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**REPLACEMENT SHEET**



300

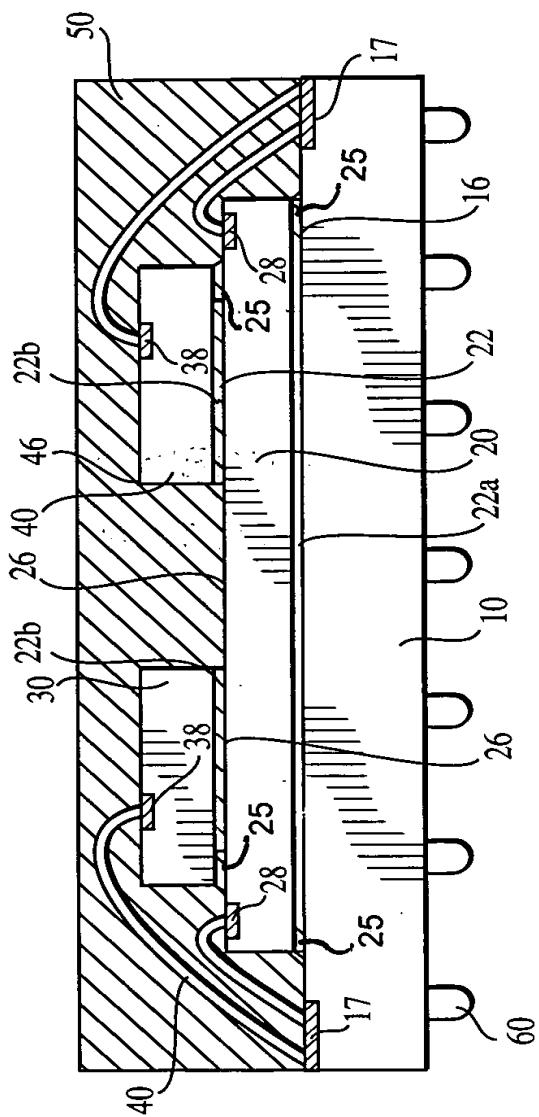


FIG. 7

**BEST AVAILABLE COPY**

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**ANNOTATED SHEET SHOWING CHANGES**

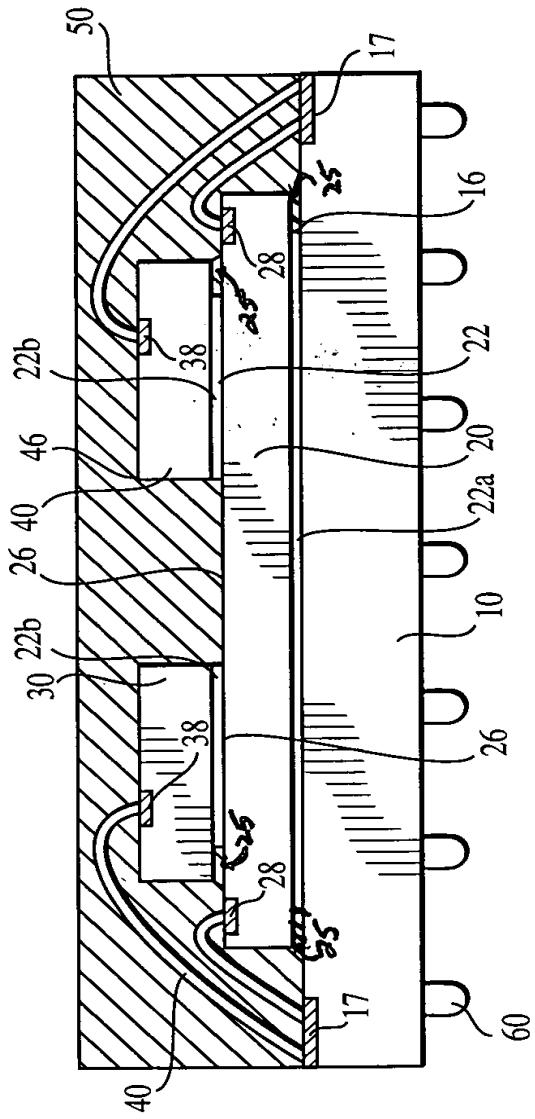
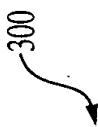


FIG. 7

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